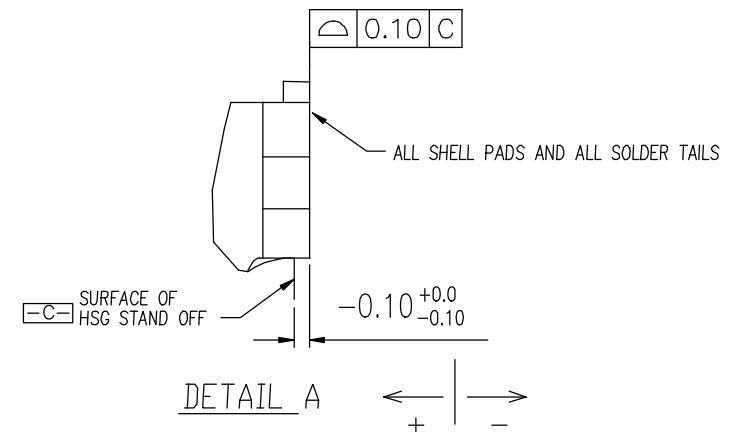
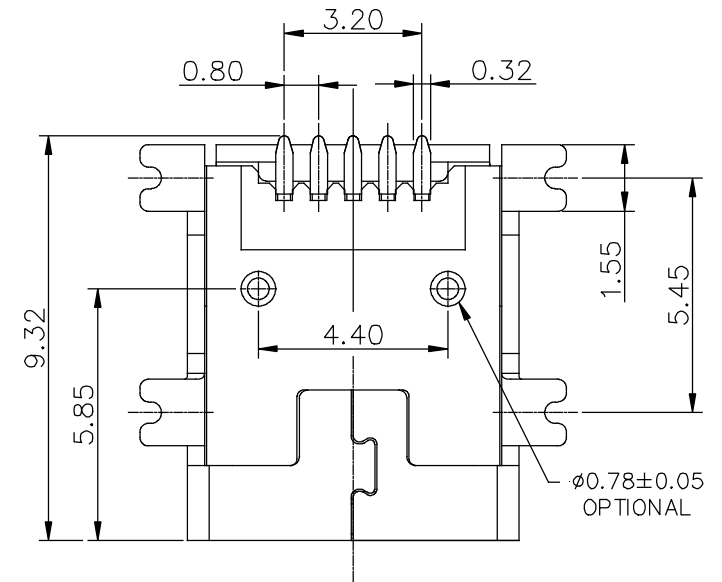
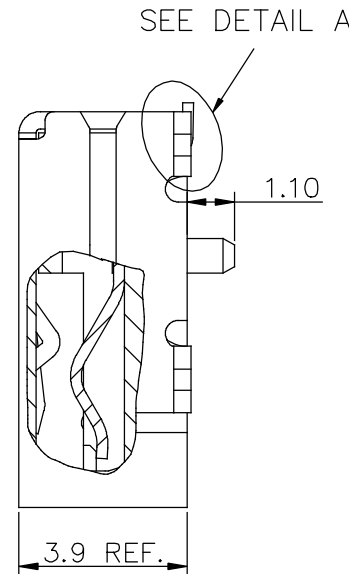
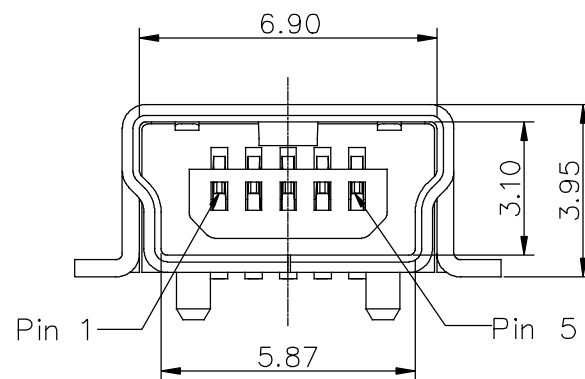
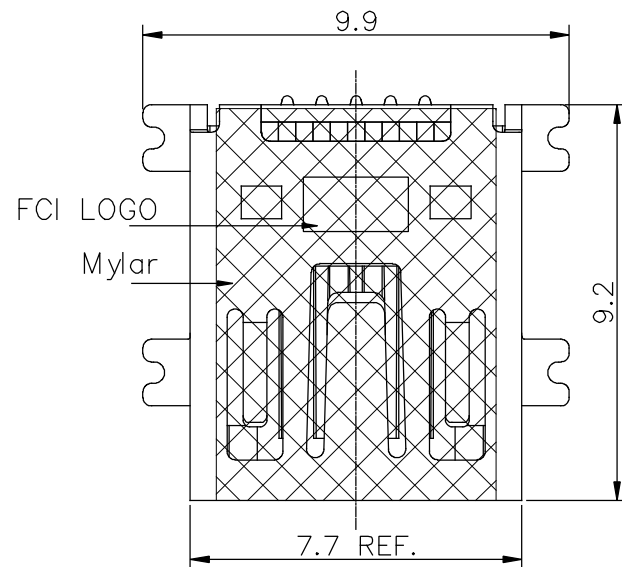




mat'l. code				tolerances unless otherwise specified			CUSTOMER COPY		FCI		
ltr	ecn no	dr	date		.X ± 0.30		projection		www.fciconnect.com		
H	T06-0074	AC	4/10/06	linear	.XX ± 0.20				title MINI USB B-TYPE SMT RECEPTACLE		
J	T06-0137	AC	7/18/06		.XXX ± 0.10						
K	T06-0201	AC	12/14/06	angles	0° ± 2°				product family 511 size dwg no 10033526		
L	T07-1002	JH	1/5/07	dr	JASON HSU	12/27/10	MM				
M	T10-0095	JH	12/27/10	enrg	JASON HSU	12/27/10			code TWN sheet 1 of 2		
N	T-004667	JH	7/27/11	chr	GARY HSIEH	12/27/10	scale N/A	A4			
				appd	JOSEPH HSIA	12/27/10					
sheet index		revision sheet		N 1	N 2						

NOTES:

1.MATERIAL:

HOUSING: THERMOPLASTIC. UL 94V-0 RATED, COLOR: BLACK.
CONTACT: COPPER ALLOY.
SHELL: COPPER ALLOY
MYLAR: KAPTON TAPE.

2.FINISH;

CONTACT: UNDERPLATED 50u"MIN. NICKEL OVERALL
100u" MIN. MATTE TIN PLATED ON SOLDERING AREA,
SELECTIVE GOLD PLATED ON CONTACT AREA.

SHIELD: CODE N: NICKEL 40u" ~120u" PLATED OVERALL.
T: SELECTIVE 60u" MIN. MATTE TIN ON LEGS OVER 40u"~120u" NICKEL.

3.10033526-X3212XLF MEETS THE EUROPEAN UNION DIRECTIVE AS DESCRIBE
IN GS-22-008 AND ITS HSG WILL WITHSTAND EXPOSE TO 260 DEGREE C
PEAK TEMPTURE FOR 10 SECONDS IN A IR REFLOW APPLICATION.

4. PRODUCT SPEC: GS-12-174 ; PACKAGE SPEC: GS-14-873.

5. PRODUCT ORDERING DATA :

FOR LEAD-FREE

10033526 - N X X X X M LF
 T T T T T T LF: Lead Free

- M: WITH MYLAR
BLANK: WITHOUT MYLAR

- PACKAGING METHOD:

2: TAPE & REEL PA

POST OPTION:
1 : WITH PLASTIC POST.
2 : WITHOUT PLASTIC POST.

- HSG MATERIAL:

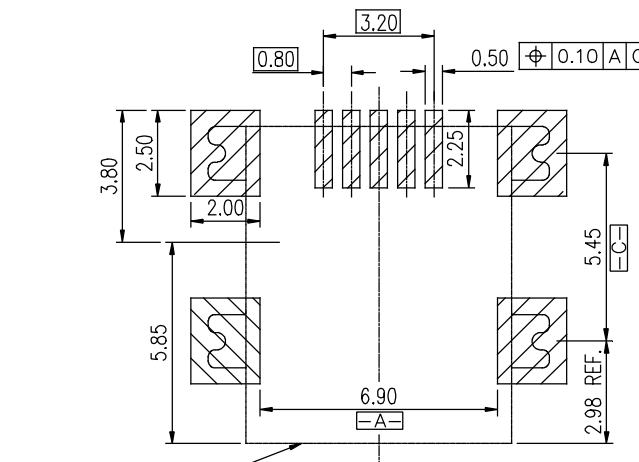
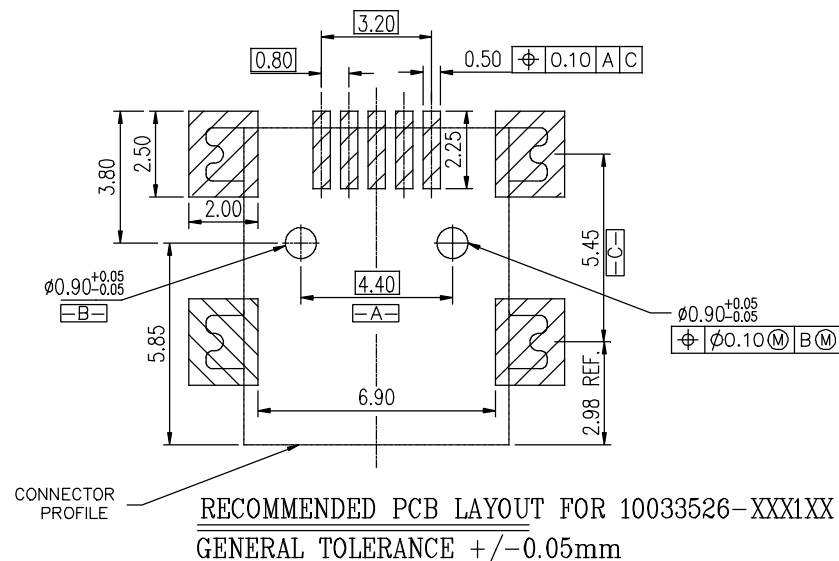
1 OR 2 : HIGH TEMP THERMOPLASTIC

- PLATING IN CONTACT AREA:

3 : 30u" Au.

— N: NICKEL FOR SHIELD.

T: SELECTIVE TIN ON LEGS.



RECOMMENDED PCB LAYOUT FOR 10033526-XXX2X
GENERAL TOLERANCE $+/-0.05\text{mm}$

[illegible]